

Figure 6 is an overhead view of the P.C. board layer 126 (i.e. a bottom view of the intentional radiator module 515) with one possible pattern for the vias 525. It will be appreciated that the vias 525 may be provided in any pattern to coupled the ground plane 135 to the shielding 110.

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IN THE CLAIMS:

Please amend claims 1, 4, 9, 14 and 18 as indicated.

Below are the amended claims in clean, unmarked format:

1. (Amended) An apparatus comprising:

an intentional radiator including an antenna and a ground plane, the ground plane to be coupled to shielding that includes an opening for the antenna, the intentional radiator to be positioned such that the antenna radiates through the opening and the ground plane at least partially blocks emissions through the opening.

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4. (Amended) An apparatus comprising:

an intentional radiator including an antenna and a ground plane; and shielding including an opening, the antenna to radiate through the opening, the shielding being coupled to the ground plane, the ground plane being oriented to at least partially block emissions through the opening.

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9. (Amended) A system comprising:

a device to be shielded;